

#### Welcome to E-XFL.COM

#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

E·XFI

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	24KB (12K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2455t-i-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## 3.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Three bits indicate the current clock source and its status. They are:

- OSTS (OSCCON<3>)
- IOFS (OSCCON<2>)
- T1RUN (T1CON<6>)

In general, only one of these bits will be set while in a given power-managed mode. When the OSTS bit is set, the primary clock is providing the device clock. When the IOFS bit is set, the INTOSC output is providing a stable, 8 MHz clock source to a divider that actually drives the device clock. When the T1RUN bit is set, the Timer1 oscillator is providing the clock. If none of these bits are set, then either the INTRC clock source is clocking the device, or the INTOSC source is not yet stable.

If the internal oscillator block is configured as the primary clock source by the FOSC3:FOSC0 Configuration bits, then both the OSTS and IOFS bits may be set when in PRI\_RUN or PRI\_IDLE modes. This indicates that the primary clock (INTOSC output) is

generating a stable 8 MHz output. Entering another power-managed RC mode at the same frequency would clear the OSTS bit.

- Note 1: Caution should be used when modifying a single IRCF bit. If VDD is less than 3V, it is possible to select a higher clock speed than is supported by the low VDD. Improper device operation may result if the VDD/Fosc specifications are violated.
  - 2: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode, or one of the Idle modes, depending on the setting of the IDLEN bit.

### 3.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

Upon resuming normal operation after waking from Sleep or Idle, the internal state machines require at least one TcY delay before another SLEEP instruction can be executed. If two back to back SLEEP instructions will be executed, the process shown in Example 3-1 should be used.

### EXAMPLE 3-1: EXECUTING BACK TO BACK SLEEP INSTRUCTIONS

SLEEP NOP ;Wait at least 1 Tcy before executing another sleep instruction SLEEP

## 3.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

### 3.2.1 PRI\_RUN MODE

The PRI\_RUN mode is the normal, full-power execution mode of the microcontroller. This is also the default mode upon a device Reset unless Two-Speed Start-up is enabled (see **Section 25.3 "Two-Speed Start-up"** for details). In this mode, the OSTS bit is set. The IOFS bit may be set if the internal oscillator block is the primary clock source (see **Section 2.4.1 "Oscillator Control Register"**).

## 3.2.2 SEC\_RUN MODE

The SEC\_RUN mode is the compatible mode to the "clock switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the Timer1 oscillator. This gives users the option of lower power consumption while still using a high-accuracy clock source.

### 3.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI\_IDLE mode, where the primary clock source is not stopped; and
- the primary clock source is not any of the XT or HS modes.

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI\_IDLE), or normally does not require an oscillator start-up delay (EC and any internal oscillator modes). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

# TABLE 3-2:EXIT DELAY ON WAKE-UP BY RESET FROM SLEEP MODE OR ANY IDLE MODE<br/>(BY CLOCK SOURCES)

Microcontrolle	r Clock Source	Evit Delev	Clock Ready Status	
Before Wake-up	e Wake-up After Wake-up		Bit (OSCCON)	
	XT, HS	XT, HS		
Primary Device Clock	XTPLL, HSPLL	None	OSTS	
(PRI_IDLE mode)	EC	None		
	INTOSC <sup>(3)</sup>		IOFS	
	XT, HS	Tost <sup>(4)</sup>		
	XTPLL, HSPLL	Tost + t <sub>rc</sub> (4)	OSTS	
	EC	TCSD <sup>(2)</sup>		
	INTOSC <sup>(3)</sup>	TIOBST <sup>(5)</sup>	IOFS	
	XT, HS	Tost <sup>(4)</sup>		
	XTPLL, HSPLL	Tost + t <sub>rc</sub> (4)	OSTS	
	EC	TCSD <sup>(2)</sup>	-	
	INTOSC <sup>(3)</sup>	None	IOFS	
	XT, HS	Tost <sup>(4)</sup>		
None	XTPLL, HSPLL	Tost + t <sub>rc</sub> (4)	OSTS	
(Sleep mode)	EC	Tcsd <sup>(2)</sup>		
	INTOSC <sup>(3)</sup>	TIOBST <sup>(5)</sup>	IOFS	

Note 1: In this instance, refers specifically to the 31 kHz INTRC clock source.

2: TCSD (parameter 38, Table 28-12) is a required delay when waking from Sleep and all Idle modes and runs concurrently with any other required delays (see Section 3.4 "Idle Modes").

- 3: Includes both the INTOSC 8 MHz source and postscaler derived frequencies.
- **4:** TOST is the Oscillator Start-up Timer period (parameter 32, Table 28-12). t<sub>rc</sub> is the PLL lock time-out (parameter F12, Table 28-9); it is also designated as TPLL.
- 5: Execution continues during TIOBST (parameter 39, Table 28-12), the INTOSC stabilization period.

NOTES:

## 4.5 Device Reset Timers

PIC18F2455/2550/4455/4550 devices incorporate three separate on-chip timers that help regulate the Power-on Reset process. Their main function is to ensure that the device clock is stable before code is executed. These timers are:

- Power-up Timer (PWRT)
- Oscillator Start-up Timer (OST)
- PLL Lock Time-out

### 4.5.1 POWER-UP TIMER (PWRT)

The Power-up Timer (PWRT) of the PIC18F2455/2550/ 4455/4550 devices is an 11-bit counter which uses the INTRC source as the clock input. This yields an approximate time interval of 2048 x 32  $\mu$ s = 65.6 ms. While the PWRT is counting, the device is held in Reset.

The power-up time delay depends on the INTRC clock and will vary from chip to chip due to temperature and process variation. See DC parameter 33 (Table 28-12) for details.

The PWRT is enabled by clearing the PWRTEN Configuration bit.

### 4.5.2 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over (parameter 33, Table 28-12). This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, HS and HSPLL modes and only on Power-on Reset or on exit from most power-managed modes.

### 4.5.3 PLL LOCK TIME-OUT

With the PLL enabled in its PLL mode, the time-out sequence following a Power-on Reset is slightly different from other oscillator modes. A separate timer is used to provide a fixed time-out that is sufficient for the PLL to lock to the main oscillator frequency. This PLL lock time-out (TPLL) is typically 2 ms and follows the oscillator start-up time-out.

### 4.5.4 TIME-OUT SEQUENCE

On power-up, the time-out sequence is as follows:

- 1. After the POR condition has cleared, PWRT time-out is invoked (if enabled).
- 2. Then, the OST is activated.

The total time-out will vary based on oscillator configuration and the status of the PWRT. Figure 4-3, Figure 4-4, Figure 4-5, Figure 4-6 and Figure 4-7 all depict time-out sequences on power-up, with the Power-up Timer enabled and the device operating in HS Oscillator mode. Figures 4-3 through 4-6 also apply to devices operating in XT mode. For devices in RC mode and with the PWRT disabled, on the other hand, there will be no time-out at all.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, all time-outs will expire. Bringing MCLR high will begin execution immediately (Figure 4-5). This is useful for testing purposes or to synchronize more than one PIC18FXXXX device operating in parallel.

Oscillator	Power-up <sup>(2)</sup> ai	Exit from		
Configuration	<b>PWRTEN</b> = 0	<b>PWRTEN</b> = 1	Power-Managed Mode	
HS, XT	66 ms <sup>(1)</sup> + 1024 Tosc	1024 Tosc	1024 Tosc	
HSPLL, XTPLL	66 ms <sup>(1)</sup> + 1024 Tosc + 2 ms <sup>(2)</sup>	1024 Tosc + 2 ms <sup>(2)</sup>	1024 Tosc + 2 ms <sup>(2)</sup>	
EC, ECIO	66 ms <sup>(1)</sup>	—	—	
ECPLL, ECPIO	66 ms <sup>(1)</sup> + 2 ms <sup>(2)</sup>	2 ms <sup>(2)</sup>	2 ms <sup>(2)</sup>	
INTIO, INTCKO	66 ms <sup>(1)</sup>	_	—	
INTHS, INTXT	66 ms <sup>(1)</sup> + 1024 Tosc	1024 Tosc	1024 Tosc	

### TABLE 4-2: TIME-OUT IN VARIOUS SITUATIONS

**Note 1:** 66 ms (65.5 ms) is the nominal Power-up Timer (PWRT) delay.

**2**: 2 ms is the nominal time required for the PLL to lock.

## 5.3.5 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM in the data memory space. SFRs start at the top of data memory and extend downward to occupy the top segment of Bank 15, from F60h to FFFh. A list of these registers is given in Table 5-1 and Table 5-2.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the

peripheral functions. The Reset and interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of a peripheral feature are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 5-1: SPECIAL FUNCTION REGIST	FER MAP
------------------------------------	---------

Address	Name	Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FDFh	INDF2 <sup>(1)</sup>	FBFh	CCPR1H	F9Fh	IPR1	F7Fh	UEP15
FFEh	TOSH	FDEh	POSTINC2 <sup>(1)</sup>	FBEh	CCPR1L	F9Eh	PIR1	F7Eh	UEP14
FFDh	TOSL	FDDh	POSTDEC2 <sup>(1)</sup>	FBDh	CCP1CON	F9Dh	PIE1	F7Dh	UEP13
FFCh	STKPTR	FDCh	PREINC2 <sup>(1)</sup>	FBCh	CCPR2H	F9Ch	(2)	F7Ch	UEP12
FFBh	PCLATU	FDBh	PLUSW2 <sup>(1)</sup>	FBBh	CCPR2L	F9Bh	OSCTUNE	F7Bh	UEP11
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON	F9Ah	(2)	F7Ah	UEP10
FF9h	PCL	FD9h	FSR2L	FB9h	(2)	F99h	(2)	F79h	UEP9
FF8h	TBLPTRU	FD8h	STATUS	FB8h	BAUDCON	F98h	(2)	F78h	UEP8
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	ECCP1DEL	F97h	(2)	F77h	UEP7
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	ECCP1AS	F96h	TRISE <sup>(3)</sup>	F76h	UEP6
FF5h	TABLAT	FD5h	T0CON	FB5h	CVRCON	F95h	TRISD <sup>(3)</sup>	F75h	UEP5
FF4h	PRODH	FD4h	(2)	FB4h	CMCON	F94h	TRISC	F74h	UEP4
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB	F73h	UEP3
FF2h	INTCON	FD2h	HLVDCON	FB2h	TMR3L	F92h	TRISA	F72h	UEP2
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	(2)	F71h	UEP1
FF0h	INTCON3	FD0h	RCON	FB0h	SPBRGH	F90h	(2)	F70h	UEP0
FEFh	INDF0 <sup>(1)</sup>	FCFh	TMR1H	FAFh	SPBRG	F8Fh	(2)	F6Fh	UCFG
FEEh	POSTINC0 <sup>(1)</sup>	FCEh	TMR1L	FAEh	RCREG	F8Eh	(2)	F6Eh	UADDR
FEDh	POSTDEC0 <sup>(1)</sup>	FCDh	T1CON	FADh	TXREG	F8Dh	LATE <sup>(3)</sup>	F6Dh	UCON
FECh	PREINC0 <sup>(1)</sup>	FCCh	TMR2	FACh	TXSTA	F8Ch	LATD <sup>(3)</sup>	F6Ch	USTAT
FEBh	PLUSW0 <sup>(1)</sup>	FCBh	PR2	FABh	RCSTA	F8Bh	LATC	F6Bh	UEIE
FEAh	FSR0H	FCAh	T2CON	FAAh	(2)	F8Ah	LATB	F6Ah	UEIR
FE9h	FSR0L	FC9h	SSPBUF	FA9h	EEADR	F89h	LATA	F69h	UIE
FE8h	WREG	FC8h	SSPADD	FA8h	EEDATA	F88h	(2)	F68h	UIR
FE7h	INDF1 <sup>(1)</sup>	FC7h	SSPSTAT	FA7h	EECON2 <sup>(1)</sup>	F87h	(2)	F67h	UFRMH
FE6h	POSTINC1 <sup>(1)</sup>	FC6h	SSPCON1	FA6h	EECON1	F86h	(2)	F66h	UFRML
FE5h	POSTDEC1 <sup>(1)</sup>	FC5h	SSPCON2	FA5h	(2)	F85h	(2)	F65h	SPPCON <sup>(3)</sup>
FE4h	PREINC1 <sup>(1)</sup>	FC4h	ADRESH	FA4h	(2)	F84h	PORTE	F64h	SPPEPS <sup>(3)</sup>
FE3h	PLUSW1 <sup>(1)</sup>	FC3h	ADRESL	FA3h	(2)	F83h	PORTD <sup>(3)</sup>	F63h	SPPCFG <sup>(3)</sup>
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	SPPDATA <sup>(3)</sup>
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	(2)
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	(2)

Note 1: Not a physical register.

2: Unimplemented registers are read as '0'.

3: These registers are implemented only on 40/44-pin devices.

### 7.2 Reading the Data EEPROM Memory

To read a data memory location, the user must write the address to the EEADR register, clear the EEPGD control bit (EECON1<7>) and then set control bit, RD (EECON1<0>). The data is available on the very next instruction cycle; therefore, the EEDATA register can be read by the next instruction. EEDATA will hold this value until another read operation or until it is written to by the user (during a write operation).

The basic process is shown in Example 7-1.

## 7.3 Writing to the Data EEPROM Memory

To write an EEPROM data location, the address must first be written to the EEADR register and the data written to the EEDATA register. The sequence in Example 7-2 must be followed to initiate the write cycle.

The write will not begin if this sequence is not exactly followed (write 55h to EECON2, write 0AAh to EECON2, then set WR bit) for each byte. It is strongly recommended that interrupts be disabled during this code segment.

Additionally, the WREN bit in EECON1 must be set to enable writes. This mechanism prevents accidental writes to data EEPROM due to unexpected code execution (i.e., runaway programs). The WREN bit should be kept clear at all times except when updating the EEPROM. The WREN bit is not cleared by hardware.

After a write sequence has been initiated, EECON1, EEADR and EEDATA cannot be modified. The WR bit will be inhibited from being set unless the WREN bit is set. The WREN bit must be set on a previous instruction. Both WR and WREN cannot be set with the same instruction.

At the completion of the write cycle, the WR bit is cleared in hardware and the EEPROM Interrupt Flag bit (EEIF) is set. The user may either enable this interrupt, or poll this bit. EEIF must be cleared by software.

## 7.4 Write Verify

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

EXAMPLE 7-1: DATA EEPROM READ

MOVLW	DATA_EE_ADDR	;
MOVWF	EEADR	; Lower bits of Data Memory Address to read
BCF	EECON1, EEPGD	; Point to DATA memory
BCF	EECON1, CFGS	; Access EEPROM
BSF	EECON1, RD	; EEPROM Read
MOVF	EEDATA, W	; W = EEDATA

EXAMPLE 7-2:	DATA EEPROM WRITE

	MOVLW	DATA EE ADD	;
	MOVWF	EEADR	; Lower bits of Data Memory Address to write
	MOVLW	DATA_EE_DAT	;
	MOVWF	EEDATA	; Data Memory Value to write
	BCF	EECON1, EEP	D ; Point to DATA memory
	BCF	EECON1, CFG	; Access EEPROM
	BSF	EECON1, WRE	; Enable writes
	BCF	INTCON, GIE	; Disable Interrupts
	MOVLW	55h	;
Required	MOVWF	EECON2	; Write 55h
Sequence	MOVLW	0AAh	;
	MOVWF	EECON2	; Write OAAh
	BSF	EECON1, WR	; Set WR bit to begin write
	BSF	INTCON, GIE	; Enable Interrupts
			; User code execution
	BCF	EECON1, WRE	; Disable writes on write complete (EEIF set)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTA	_	RA6 <sup>(1)</sup>	RA5	RA4	RA3	RA2	RA1	RA0	56
LATA	—	LATA6 <sup>(1)</sup>	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	56
TRISA	—	TRISA6 <sup>(1)</sup>	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	56
ADCON1	—	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	54
CMCON	C2OUT	C10UT	C2INV	C1INV	CIS	CM2	CM1	CM0	55
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	55
UCON	_	PPBRST	SE0	PKTDIS	USBEN	RESUME	SUSPND		57

### TABLE 10-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

**Note 1:** RA6 and its associated latch and data direction bits are enabled as I/O pins based on oscillator configuration; otherwise, they are read as '0'.

## 17.4 Buffer Descriptors and the Buffer Descriptor Table

The registers in Bank 4 are used specifically for endpoint buffer control in a structure known as the Buffer Descriptor Table (BDT). This provides a flexible method for users to construct and control endpoint buffers of various lengths and configuration.

The BDT is composed of Buffer Descriptors (BD) which are used to define and control the actual buffers in the USB RAM space. Each BD, in turn, consists of four registers, where n represents one of the 64 possible BDs (range of 0 to 63):

- BDnSTAT: BD Status register
- BDnCNT: BD Byte Count register
- · BDnADRL: BD Address Low register
- BDnADRH: BD Address High register

BDs always occur as a four-byte block in the sequence, BDnSTAT:BDnCNT:BDnADRL:BDnADRH. The address of BDnSTAT is always an offset of (4n - 1) (in hexadecimal) from 400h, with n being the buffer descriptor number.

Depending on the buffering configuration used (Section 17.4.4 "Ping-Pong Buffering"), there are up to 32, 33 or 64 sets of buffer descriptors. At a minimum, the BDT must be at least 8 bytes long. This is because the USB specification mandates that every device must have Endpoint 0 with both input and output for initial setup. Depending on the endpoint and buffering configuration, the BDT can be as long as 256 bytes.

Although they can be thought of as Special Function Registers, the Buffer Descriptor Status and Address registers are not hardware mapped, as conventional microcontroller SFRs in Bank 15 are. If the endpoint corresponding to a particular BD is not enabled, its registers are not used. Instead of appearing as unimplemented addresses, however, they appear as available RAM. Only when an endpoint is enabled by setting the UEPn<1> bit does the memory at those addresses become functional as BD registers. As with any address in the data memory space, the BD registers have an indeterminate value on any device Reset.

An example of a BD for a 64-byte buffer, starting at 500h, is shown in Figure 17-6. A particular set of BD registers is only valid if the corresponding endpoint has been enabled using the UEPn register. All BD registers are available in USB RAM. The BD for each endpoint should be set up prior to enabling the endpoint.

### 17.4.1 BD STATUS AND CONFIGURATION

Buffer descriptors not only define the size of an endpoint buffer, but also determine its configuration and control. Most of the configuration is done with the BD Status register, BDnSTAT. Each BD has its own unique and correspondingly numbered BDnSTAT register.

#### FIGURE 17-6: EXAMPLE OF A BUFFER DESCRIPTOR



Unlike other control registers, the bit configuration for the BDnSTAT register is context sensitive. There are two distinct configurations, depending on whether the microcontroller or the USB module is modifying the BD and buffer at a particular time. Only three bit definitions are shared between the two.

### 17.4.1.1 Buffer Ownership

Because the buffers and their BDs are shared between the CPU and the USB module, a simple semaphore mechanism is used to distinguish which is allowed to update the BD and associated buffers in memory.

This is done by using the UOWN bit (BDnSTAT<7>) as a semaphore to distinguish which is allowed to update the BD and associated buffers in memory. UOWN is the only bit that is shared between the two configurations of BDnSTAT.

When UOWN is clear, the BD entry is "owned" by the microcontroller core. When the UOWN bit is set, the BD entry and the buffer memory are "owned" by the USB peripheral. The core should not modify the BD or its corresponding data buffer during this time. Note that the microcontroller core can still read BDnSTAT while the SIE owns the buffer and vice versa.

The buffer descriptors have a different meaning based on the source of the register update. Prior to placing ownership with the USB peripheral, the user can configure the basic operation of the peripheral through the BDnSTAT bits. During this time, the byte count and buffer location registers can also be set.

When UOWN is set, the user can no longer depend on the values that were written to the BDs. From this point, the SIE updates the BDs as necessary, overwriting the original BD values. The BDnSTAT register is updated by the SIE with the token PID and the transfer count, BDnCNT, is updated.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Details on page
PIE2	OSCFIE	CMIE	USBIE	EEIE	BCLIE	HLVDIE	TMR3IE	CCP2IE	56
UCON	_	PPBRST	SE0	PKTDIS	USBEN	RESUME	SUSPND	—	57
UCFG	UTEYE	UOEMON	_	UPUEN	UTRDIS	FSEN	PPB1	PPB0	57
USTAT	_	ENDP3	ENDP2	ENDP1	ENDP0	DIR	PPBI	—	57
UADDR	_	ADDR6	ADDR5	ADDR4	ADDR3	ADDR2	ADDR1	ADDR0	57
UFRML	FRM7	FRM6	FRM5	FRM4	FRM3	FRM2	FRM1	FRM0	57
UFRMH	_	—	_	_	—	FRM10	FRM9	FRM8	57
UIR	_	SOFIF	STALLIF	IDLEIF	TRNIF	ACTVIF	UERRIF	URSTIF	57
UIE	_	SOFIE	STALLIE	IDLEIE	TRNIE	ACTVIE	UERRIE	URSTIE	57
UEIR	BTSEF	_	_	BTOEF	DFN8EF	CRC16EF	CRC5EF	PIDEF	57
UEIE	BTSEE	—	_	BTOEE	DFN8EE	CRC16EE	CRC5EE	PIDEE	57
UEP0	_	—	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP1	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP2	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP3		—		EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP4	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP5	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP6	_	—	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP7	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP8	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP9	_	—	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP10	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP11	-	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP12	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP13	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP14	_	_	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57
UEP15	_	—	_	EPHSHK	EPCONDIS	EPOUTEN	EPINEN	EPSTALL	57

**Legend:** — = unimplemented, read as '0'. Shaded cells are not used by the USB module.

**Note 1:** This table includes only those hardware mapped SFRs located in Bank 15 of the data memory space. The Buffer Descriptor registers, which are mapped into Bank 4 and are not true SFRs, are listed separately in Table 17-5.

### 18.3.3 READING FROM THE SPP

Reading from the SPP involves reading the SPPDATA register. Reading the register the first time initiates the read operation. When the read is finished, indicated by the SPPBUSY bit, the SPPDATA will be loaded with the current data.

The following is an example read sequence:

- 1. Write the 4-bit address to the SPPEPS register. The SPP automatically starts writing the address. If address write is not used then skip to step 3.
- 2. Monitor the SPPBUSY bit to determine when the address has been sent. The duration depends on the wait states.

- 3. Read the data from the SPPDATA register; the data from the previous read operation is returned. The SPP automatically starts the read cycle for the next read.
- 4. Monitor the SPPBUSY bit to determine when the data has been read. The duration depends on the wait states.
- 5. Go back to step 3 to read the current byte from the SPP and start the next read cycle.

### REGISTER 18-3: SPPEPS: SPP ENDPOINT ADDRESS AND STATUS REGISTER

R-0	R-0	U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
RDSPP	WRSPP	—	SPPBUSY	ADDR3	ADDR2	ADDR1	ADDR0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	<b>RDSPP:</b> SPP Read Status bit (Valid when SPPCON <sppown> = 1, USB) 1 = The last transaction was a read from the SPP 0 = The last transaction was not a read from the SPP</sppown>						
bit 6	WRSPP: SPP Write Status bit (Valid when SPPCON <sppown> = 1, USB) 1 = The last transaction was a write to the SPP 0 = The last transaction was not a write to the SPP</sppown>						
bit 5	Unimplemented: Read as '0'						
bit 4	<b>SPPBUSY:</b> SPP Handshaking Override bit 1 = The SPP is busy 0 = The SPP is ready to accept another read or write request						
bit 3-0	ADDR3:ADDR0: SPP Endpoint Address bits						
	1111 = Endpoint Address 15						
	• •						
	• •						
	0001						
	0000 = Endpoint Address 0						

### 19.4.3.2 Address Masking

Masking an address bit causes that bit to become a "don't care". When one address bit is masked, two addresses will be Acknowledged and cause an interrupt. It is possible to mask more than one address bit at a time, which makes it possible to Acknowledge up to 31 addresses in 7-bit mode and up to 63 addresses in 10-bit mode (see Example 19-3).

The  $l^2C$  Slave behaves the same way whether address masking is used or not. However, when address masking is used, the  $l^2C$  slave can Acknowledge multiple addresses and cause interrupts. When this occurs, it is necessary to determine which address caused the interrupt by checking SSPBUF.

In 7-Bit Address mode, address mask bits ADMSK<5:1> (SSPCON2<5:1>) mask the corresponding address bits in the SSPADD register. For any ADMSK bits that are set (ADMSK<n> = 1), the corresponding address bit is ignored (SSPADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

In 10-Bit Address mode, bits ADMSK<5:2> mask the corresponding address bits in the SSPADD register. In addition, ADMSK1 simultaneously masks the two LSbs of the address (SSPADD<1:0>). For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (SSPADD<n> = x). Also note that although in 10-Bit Addressing mode, the upper address bits reuse part of the SSPADD register bits, the address mask bits do not interact with those bits. They only affect the lower address bits.

- Note 1: ADMSK1 masks the two Least Significant bits of the address.
  - The two Most Significant bits of the address are not affected by address masking.

### EXAMPLE 19-3: ADDRESS MASKING EXAMPLES

#### 7-bit addressing:

SSPADD<7:1> = A0h (1010000) (SSPADD<0> is assumed to be '0')

ADMSK<5:1> = 00111

Addresses Acknowledged : A0h, A2h, A4h, A6h, A8h, AAh, ACh, AEh

#### 10-bit addressing:

SSPADD<7:0> = A0h (10100000) (The two MSbs of the address are ignored in this example, since they are not affected by masking)

ADMSK<5:1> = 00111

Addresses Acknowledged: A0h, A1h, A2h, A3h, A4h, A5h, A6h, A7h, A8h, A9h, AAh, ABh, ACh, ADh, AEh, AFh

### FIGURE 20-3: EUSART TRANSMIT BLOCK DIAGRAM



### FIGURE 20-4: ASYNCHRONOUS TRANSMISSION, TXCKP = 0 (TX NOT INVERTED)



### FIGURE 20-5: ASYNCHRONOUS TRANSMISSION (BACK TO BACK), TXCKP = 0 (TX NOT INVERTED)



## REGISTER 25-7: CONFIG5L: CONFIGURATION REGISTER 5 LOW (BYTE ADDRESS 300008h)

U-0	U-0	U-0	U-0	R/C-1	R/C-1	R/C-1	R/C-1	
—		_	—	CP3 <sup>(1)</sup>	CP2	CP1	CP0	
bit 7								
Legend:								
R = Readable bit C = Clearable bit			U = Unimpler	mented bit, read	as '0'			
-n = Value when device is unprogrammed				u = Unchang	ed from progran	nmed state		

bit 7-4	Unimplemented: Read as '0'
bit 3	CP3: Code Protection bit <sup>(1)</sup>
	1 = Block 3 (006000-007FFFh) is not code-protected 0 = Block 3 (006000-007FFFh) is code-protected
bit 2	CP2: Code Protection bit
	1 = Block 2 (004000-005FFFh) is not code-protected 0 = Block 2 (004000-005FFFh) is code-protected
bit 1	CP1: Code Protection bit
	1 = Block 1 (002000-003FFFh) is not code-protected 0 = Block 1 (002000-003FFFh) is code-protected
bit 0	CP0: Code Protection bit
	1 = Block 0 (000800-001FFFh) is not code-protected 0 = Block 0 (000800-001FFFh) is code-protected

Note 1: Unimplemented in PIC18FX455 devices; maintain this bit set.

## REGISTER 25-8: CONFIG5H: CONFIGURATION REGISTER 5 HIGH (BYTE ADDRESS 300009h)

R/C-1	R/C-1	U-0	U-0	U-0	U-0	U-0	U-0
CPD	СРВ	—	—	—	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	C = Clearable bit	U = Unimplemented bit, read as '0'
-n = Value when device is un	programmed	u = Unchanged from programmed state

bit 7	CPD: Data EEPROM Code Protection bit
	1 = Data EEPROM is not code-protected
	0 = Data EEPROM is code-protected
bit 6	CPB: Boot Block Code Protection bit
	<ul><li>1 = Boot block (000000-0007FFh) is not code-protected</li><li>0 = Boot block (000000-0007FFh) is code-protected</li></ul>
bit 5-0	Unimplemented: Read as '0'

### TABLE 26-2: PIC18FXXXX INSTRUCTION SET

Mnemonic,		Description	Cycles	16-	Bit Instr	uction W	/ord	Status	Notoc
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BYTE-ORI	ENTED O	OPERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f <sub>s</sub> , f <sub>d</sub>	Move f <sub>s</sub> (source) to 1st word	2	1100	ffff	ffff	ffff	None	
	0 u	f <sub>d</sub> (destination) 2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N	
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2
SUBFWB	f, d, a	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	
		Borrow							
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2
SUBWFB	f, d, a	Subtract WREG from f with	1	0101	10da	ffff	ffff	C, DC, Z, OV, N	
		Borrow							
SWAPF	f, d, a	Swap Nibbles in f	1	0011	10da	ffff	ffff	None	4
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1	0001	10da	ffff	ffff	Z, N	

**Note 1:** When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as an input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and where applicable, 'd' = 1), the prescaler will be cleared if assigned.

**3:** If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

BCF	Bit Clear f	BN	Branch if	Negative	
Syntax:	BCF f, b {,a}	Syntax:	BN n		
Operands:	$0 \le f \le 255$	Operands:	-128 ≤ n ≤	127	
	$\begin{array}{l} 0 \leq b \leq 7 \\ a \in [0,1] \end{array}$	Operation:	if Negative bit is '1', (PC) + 2 + 2n $\rightarrow$ PC		
Operation:	$0 \rightarrow f \le b >$	Status Affected:	None		
Status Affected:	None	Encodina <sup>.</sup>	1110	0110 ppr	מממת מר
Encoding:	1001 bbba ffff ffff	Description:	If the Nega	tive bit is '1' th	
Description:	Bit 'b' in register 'f' is cleared. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing made with provide (SE) (SE).		program w The 2's con added to th incremente instruction, PC + 2 + 2 two-cycle i	ill branch. nplement num le PC. Since th d to fetch the r the new addre n. This instruct nstruction.	ber '2n' is e PC will have next ess will be ion is then a
	mode whenever t ≤ 95 (5Fn). See Section 26 2 3 "Byte-Oriented and	Words:	1		
	Bit-Oriented Instructions in Indexed	Cycles:	1(2)		
Words:	Literal Offset Mode" for details.	Q Cycle Activity: If Jump:			
Cvcles:	1	Q1	Q2	Q3	Q4
Q Cycle Activity:		Decode	Read literal 'n'	Process Data	Write to PC
Q1	Q2 Q3 Q4	No	No	No	No
Decode	Read Process Write	operation	operation	operation	operation
		If No Jump:			<i>.</i>
Example:	BCE FLAG REG. 7. 0	Q1	Q2	Q3	Q4
Before Instruc	tion	Decode	read literal	Data	operation
FLAG_R After Instructio	EG = C7h				operation
FLAG_R	EG = 47h	Example:	HERE	BN Jump	
		Before Instruc PC After Instructio	ction = ac on	Idress (HERE)	
		If Negati PC If Negati PC	ve = 1; = ac ve = 0; = ac	ldress (Jump) ldress (HERE	+ 2)

XORWF	Exclusive OR W with f					
Syntax:	XORWF	f {,d {,a}}				
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d  \in  [0,1] \\ a  \in  [0,1] \end{array}$					
Operation:	(W) .XOR.	(f) $\rightarrow$ dest				
Status Affected:	N, Z					
Encoding:	0001	10da ff:	ff ffff			
Description:	Exclusive OR the contents of W with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored bac in the register 'f' (default). If 'a' is '0', the Access Bank is selecter If 'a' is '1', the BSR is used to select th GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 26.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	Q4			
Decode	Read register 'f'	Process Data	Write to destination			
Example:	XORWF 1	REG, 1, 0				
Before Instruct	ion					
REG	= AFh = B5h					
After Instructio	n - 10011					
REG W	= 1Ah = B5h					

## FIGURE 28-10: CAPTURE/COMPARE/PWM TIMINGS (ALL CCP MODULES)



TABLE 28-14: CAPTURE/COMPARE/PWM REQUIREMENTS (ALL CCP MODULES)

Param No.	Symbol	с	haracterist	ic	Min	Мах	Units	Conditions
50	TccL	CCPx Input Low	No prescal	er	0.5 Tcy + 20	—	ns	
		Time	With	PIC18FXXXX	10	—	ns	
			prescaler	PIC18LFXXXX	20	_	ns	VDD = 2.0V
51	TccH CCPx Input No presca		No prescal	er	0.5 Tcy + 20	—	ns	
		High Time	With	PIC18FXXXX	10	—	ns	
			prescaler	PIC18LFXXXX	20	—	ns	VDD = 2.0V
52	TccP	CCPx Input Period			<u>3 Tcy + 40</u> N	—	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fa	ll Time	PIC18FXXXX	—	25	ns	
				PIC18LFXXXX	—	45	ns	VDD = 2.0V
54	54 TccF CCPx Output Fall Time		PIC18FXXXX	—	25	ns		
				PIC18LFXXXX	_	45	ns	VDD = 2.0V

Param No.	Symbol	Characteristic		Min	Мах	Units	Conditions
130	Tad	A/D Clock Period	PIC18FXXXX	0.8	25.0 <sup>(1)</sup>	μS	Tosc based, VREF $\geq$ 3.0V
			PIC18LFXXXX	1.4	25.0 <sup>(1)</sup>	μS	VDD = 2.0V, Tosc based, VREF full range
			PIC18FXXXX	—	1	μS	A/D RC mode
			PIC18LFXXXX	—	3	μS	V <sub>DD</sub> = 2.0V, A/D RC mode
131	TCNV	Conversion Time (not including acquisition	on time) <sup>(2)</sup>	11	12	Tad	
132	TACQ	Acquisition Time <sup>(3)</sup>	1.4	—	μS	-40°C to +85°C	
135	Tswc	Switching Time from C	—	(Note 4)			
137	TDIS	Discharge Time		0.2	_	μS	

### TABLE 28-29: A/D CONVERSION REQUIREMENTS

Note 1: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TCY cycle.

**3:** The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (Vss to VDD). The source impedance (*Rs*) on the input channels is  $50\Omega$ .

4: On the following cycle of the device clock.

## 44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dimensi	on Limits	MIN	NOM	MAX	
Number of Leads	Ν		44		
Lead Pitch	е		0.80 BSC		
Overall Height	А	1	_	1.20	
Molded Package Thickness	A2	0.95	1.00	1.05	
Standoff	A1	0.05	-	0.15	
Foot Length	L	0.45	0.60	0.75	
Footprint	L1	1.00 REF			
Foot Angle	ф	0°	3.5°	7°	
Overall Width	E		12.00 BSC		
Overall Length	D		12.00 BSC		
Molded Package Width	E1		10.00 BSC		
Molded Package Length	D1		10.00 BSC		
Lead Thickness	С	0.09 – 0.20			
Lead Width	b	0.30	0.37	0.45	
Mold Draft Angle Top	α	11° 12° 13°			
Mold Draft Angle Bottom	β	11°	12°	13°	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

## APPENDIX C: CONVERSION CONSIDERATIONS

This appendix discusses the considerations for converting from previous versions of a device to the ones listed in this data sheet. Typically, these changes are due to the differences in the process technology used. An example of this type of conversion is from a PIC16C74A to a PIC16C74B.

Not Applicable

## APPENDIX D: MIGRATION FROM BASELINE TO ENHANCED DEVICES

This section discusses how to migrate from a Baseline device (i.e., PIC16C5X) to an Enhanced MCU device (i.e., PIC18FXXX).

The following are the list of modifications over the PIC16C5X microcontroller family:

Not Currently Available